



## DP0150ALP4 / DP0150BLP4

### **50V PNP SMALL SIGNAL SURFACE MOUNT TRANSISTOR**

### **Features**

- Epitaxial Die Construction
- Ultra-Small Leadless Surface Mount Package
- Ultra-low Profile (0.40mm max)
- Complementary NPN Type Available (DN0150ALP4 / DN0150BLP4)
- "Lead Free", RoHS Compliant (Note 1)
- Halogen and Antimony Free, "Green" Device (Note 2)
- Qualified to AEC-Q101Standards for High Reliability

## **Mechanical Data**

- Case: DFN1006H4-3
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.0008 grams (approximate)

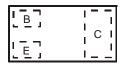
### DFN1006H4-3







Device Symbol



Top View Device Schematic

## **Ordering Information (Note 3)**

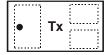
Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
DP0150ALP4-7	T5	7	8	3,000
DP0150ALP4-7B	T5	7	8	10,000
DP0150BLP4-7	T6	7	8	3,000
DP0150BLP4-7B	T6	7	8	10,000

Notes:

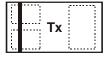
- 1. No purposefully added lead.
- 2. Diodes Inc's "Green" policy can be found on our website at http://www.diodes.com
- 3. For packaging details, go to our website at http://www.diodes.com.

## **Marking Information**

DP0150ALP4-7 DP0150BLP4-7



Top View Dot Denotes Collector Side DP0150ALP4-7B DP0150BLP4-7B



Top View Bar Denotes Base and Emitter Side Tx = Product Type Marking Code T5 = DP0150ALP4

T6 = DP0150BLP4



# Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	$V_{CBO}$	-50	V
Collector-Emitter Voltage	$V_{CEO}$	-50	V
Emitter-Base Voltage	$V_{EBO}$	-5	V
Collector Current - Continuous	lc	-100	mA
Peak Pulse Collector Current	I <sub>CM</sub>	-200	mA
Base Current	I <sub>B</sub>	-30	mA

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4)	$P_{D}$	450	mW
Thermal Resistance, Junction to Ambient (Note 4)	$R_{ hetaJA}$	278	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

# Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS							
Collector-Base Breakdown Voltage		V(BR)CBO	-50	_	_	V	$I_C = -10\mu A, I_E = 0$
Collector-Emitter Breakdown Voltage (Note 5)		V(BR)CEO	-50	_	_	V	$I_C = -1 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage		V( <sub>BR)EBO</sub>	-5	_	_	V	$I_E = -10\mu A, I_C = 0$
Collector Cut-Off Current		I <sub>CBO</sub>	_	_	-0.1	μΑ	$V_{CB} = -50V, I_{E} = 0$
Emitter Cut-Off Current		I <sub>EBO</sub>	_	_	-0.1	μΑ	$V_{EB} = -5V, I_{C} = 0$
ON CHARACTERISTICS (Note 5)	ON CHARACTERISTICS (Note 5)						
Collector-Emitter Saturation Voltage		V <sub>CE(SAT)</sub>	_	-0.15	-0.3	V	$I_C = -100 \text{mA}, I_B = -10 \text{mA}$
DC Current Gain	DP01510ALP4 DP01510BLP4	h <sub>FE</sub>	120 200		240 400	_	$V_{CE} = -6V, I_{C} = -2mA$
SMALL SIGNAL CHARACTERISTICS							
Transition Frequency		f <sub>T</sub>	80	_		MHz	$V_{CE} = -10V$ , $I_E = 1mA$ f = 30MHz
Output Capactiance		C <sub>ob</sub>	_	1.6	_	pF	$V_{CB} = -10V, I_E = 0,$ f = 1MHz

Notes:

<sup>4.</sup> Device mounted on FR-4 PCB with minimum recommended pad layout.

<sup>5.</sup> Measured under pulsed conditions. Pulse width = 300µs. Duty cycle ≤2%





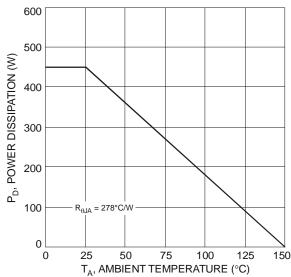
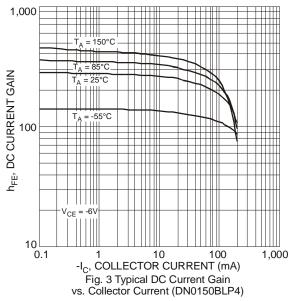
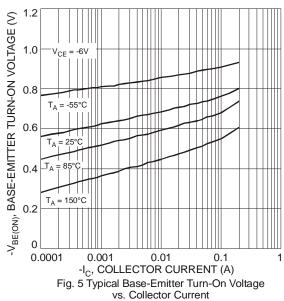
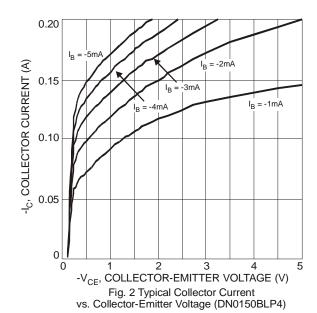
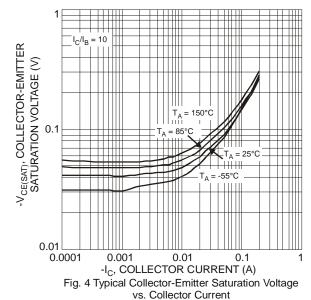


Fig. 1 Power Dissipation vs. Ambient Temperature (Note 3)



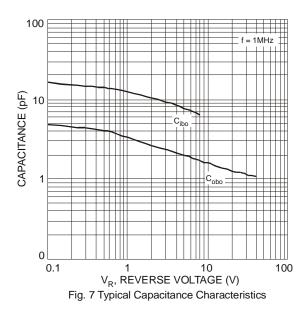


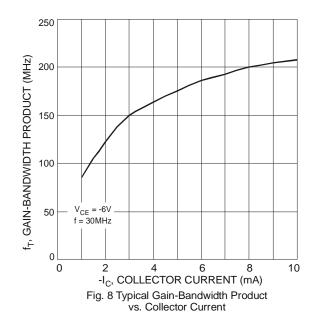




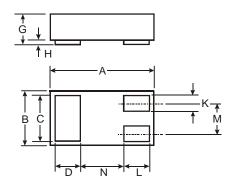






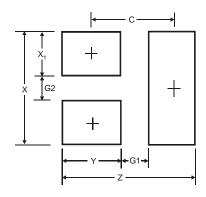


# **Package Outline Dimensions**



DFN1006H4-3					
Dim	Min	Max	Тур		
Α	0.95	1.075	1.00		
В	0.55	0.675	0.60		
С	0.45	0.55	0.50		
D	0.20	0.30	0.25		
G	_	0.40			
Н	0	0.05	0.02		
K	0.10	0.20	0.15		
L	0.20	0.30	0.25		
М		_	0.35		
N	_	_	0.40		
All	All Dimensions in mm				

# **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	1.1
G1	0.3
G2	0.2
Х	0.7
X1	0.25
Υ	0.4
С	0.7



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